



#### N-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

| BV <sub>DSS</sub> | R <sub>DS(ON)</sub> max       | I <sub>D</sub> max<br>T <sub>A</sub> = +25°C |
|-------------------|-------------------------------|--|
| 201/              | $29m\Omega$ @ $V_{GS} = 10V$  | 6.5A   |
| 20V               | $35m\Omega$ @ $V_{GS} = 4.5V$ | 5.4A   |

## **Description**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

- General Purpose Interfacing Switch
- Power Management Functions

## **Features**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

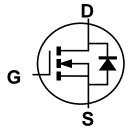
### **Mechanical Data**

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (§3)
- Terminals Connections: See Diagram Below
- Weight: 0.008 grams (Approximate)

SOT23







**Equivalent Circuit** 

## **Ordering Information** (Notes 4)

| Part Number | Case  | Packaging         |
|-------------|-------|-------------------|
| DMN2053U-7  | SOT23 | 3000/Tape & Reel  |
| DMN2053U-13 | SOT23 | 10000/Tape & Reel |

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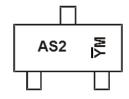
Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

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- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



 $\frac{AS2}{YM}$  = Product Type Marking Code  $\frac{YM}{Y}$  = Date Code Marking  $\frac{Y}{Y}$  = Last Digit of Year (ex: 8 = 2018)  $\frac{Y}{Y}$  = Month (ex: 9 = September)

Date Code Key

| Year  | 2017 | 2018 | 20  | 019 | 2020 | 2021 | 1  | 2  | 022 | 2023 | 202 | 24  | 2025 |
|-------|------|------|-----|-----|------|------|----|----|-----|------|-----|-----|------|
| Code  | Е    | F    |     | G   | Н    | ı    |    |    | J   | K    | L   |     | М    |
| Month | Jan  | Feb  | Mar | Apr | May  | Jun  | Ju | ıl | Aug | Sep  | Oct | Nov | Dec  |
| Code  | 1    | 2    | 3   | 4   | 5    | 6    | 7  | '  | 8   | 9    | 0   | N   | D    |



# **Maximum Ratings** $(@T_A = +25^{\circ}C, \text{ unless otherwise specified.})$

| Characte  | eristic         |                  | Symbol          | Value      | Unit |
|---|-----------------|------------------|-----------------|------------|------|
| Drain-Source Voltage  |                 | V <sub>DSS</sub> | 20              | V          |      |
| Gate-Source Voltage   |                 | V <sub>GSS</sub> | ±12             | V          |      |
| Continuous Drain Current (Note 6) Steady $T_A = +25^{\circ}C$<br>State $T_A = +70^{\circ}C$ |                 |                  | I <sub>D</sub>  | 6.5<br>5.4 | А    |
| Pulsed Drain Current (380µs Pulse, Du   | uty Cycle = 1%) |                  | I <sub>DM</sub> | 22         | Α    |

## Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

| Characteristic                                   | Symbol          | Value          | Unit |      |
|--|-----------------|----------------|------|------|
| Total Power Dissipation (Note 5)                 |                 | P <sub>D</sub> | 0.8  | W    |
| Thermal Resistance, Junction to Ambient (Note 5) | $R_{	heta JA}$  | 160            | °C/W |      |
| Total Power Dissipation (Note 6)                 | ·               | P <sub>D</sub> | 1.3  | W    |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State    | $R_{	heta JA}$ | 93   | °C/W |
| Operating and Storage Temperature Range          | $T_{J,}T_{STG}$ | -55 to +150    | °C   |      |

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic   | Symbol                      | Min | Тур  | Max  | Unit   | Test Condition                              |  |
|--|-----------------------------|-----|------|------|--------|---|--|
| OFF CHARACTERISTICS (Note 7)                           |                             |     |      |      |        |   |  |
| Drain-Source Breakdown Voltage                         | BV <sub>DSS</sub>           | 20  | 1    |      | V      | $V_{GS} = 0V, I_D = 250\mu A$               |  |
| Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C | I <sub>DSS</sub>            | _   | _    | 1.0  | μA     | $V_{DS} = 20V, V_{GS} = 0V$                 |  |
| Gate-Source Leakage                                    | I <sub>GSS</sub>            | _   | _    | ±100 | nA     | $V_{GS} = \pm 12V$ , $V_{DS} = 0V$          |  |
| ON CHARACTERISTICS (Note 7)                            | ON CHARACTERISTICS (Note 7) |     |      |      |        |   |  |
| Gate Threshold Voltage                                 | V <sub>GS(TH)</sub>         | 0.5 | 0.95 | 1.2  | V      | $V_{DS} = V_{GS}$ , $I_D = 250\mu A$        |  |
|  |                             |     | 26   | 29   |        | $V_{GS} = 10V, I_D = 6A$                    |  |
| Static Drain-Source On-Resistance                      | D                           |     | 28   | 35   | mΩ     | $V_{GS} = 4.5V, I_D = 5A$                   |  |
| Static Dialit-Source Off-Resistance                    | R <sub>DS(ON)</sub>         | _   | 35   | 48   | 1117.7 | $V_{GS} = 2.5V, I_D = 4A$                   |  |
|  |                             |     | 47   | 91   |        | $V_{GS} = 1.8V, I_D = 2A$                   |  |
| Diode Forward Voltage                                  | V <sub>SD</sub>             | _   | 0.7  | 1.0  | V      | V <sub>GS</sub> = 0V, I <sub>S</sub> = 1A   |  |
| DYNAMIC CHARACTERISTICS (Note 8)                       |                             |     |      |      | •      |   |  |
| Input Capacitance                                      | C <sub>iss</sub>            | _   | 414  | _    | pF     |   |  |
| Output Capacitance                                     | Coss                        |     | 58   | _    | pF     | $V_{DS} = 10V, V_{GS} = 0V,$<br>f = 1.0MHz  |  |
| Reverse Transfer Capacitance                           | C <sub>rss</sub>            | _   | 43   | _    | pF     | 1 - 1.000112                                |  |
| Gate Resistance  | Rg                          | _   | 3.6  | _    | Ω      | $V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$  |  |
| Total Gate Charge                                      | Qg                          | _   | 4.6  | _    | nC     | 151/1/                                      |  |
| Gate-Source Charge                                     | Qgs                         | _   | 0.5  | _    | nC     | $V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 6A$ |  |
| Gate-Drain Charge                                      | Q <sub>gd</sub>             | _   | 1.4  | _    | nC     | 1D = 0A                                     |  |
| Turn-On Delay Time                                     | t <sub>D(ON)</sub>          | _   | 2.6  | _    | ns     |   |  |
| Turn-On Rise Time                                      | t <sub>R</sub>              |     | 2.9  | _    | ns     | $V_{DD} = 10V, V_{GS} = 5V,$                |  |
| Turn-Off Delay Time                                    | t <sub>D(OFF)</sub>         | _   | 13.5 | _    | ns     | $R_L = 1.7\Omega$ , $R_G = 6\Omega$         |  |
| Turn-Off Fall Time                                     | t <sub>F</sub>              |     | 3.8  |      | ns     | 1   |  |
| Reverse Recovery Time                                  | t <sub>RR</sub>             | 1   | 6.8  | -    | ns     | $I_F = 1.0A$ , $di/dt = 100A/\mu s$         |  |
| Reverse Recovery Charge                                | Q <sub>RR</sub>             |     | 1.2  | _    | nC     | $I_F = 1.0A$ , $di/dt = 100A/\mu s$         |  |

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
   Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
   Short duration pulse test used to minimize self-heating effect.
   Guaranteed by design. Not subject to product testing



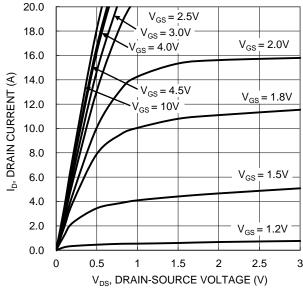


Figure 1. Typical Output Characteristic

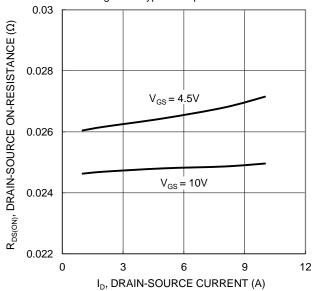


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

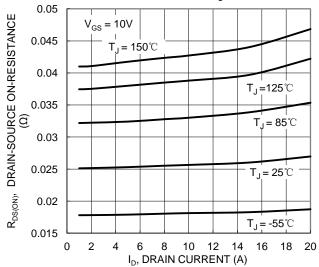


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

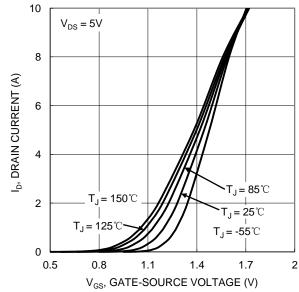


Figure 2. Typical Transfer Characteristic

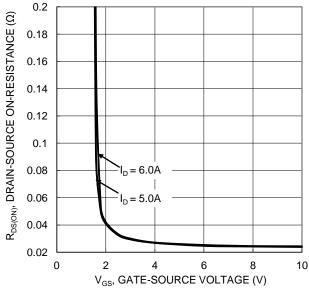


Figure 4. Typical Transfer Characteristic

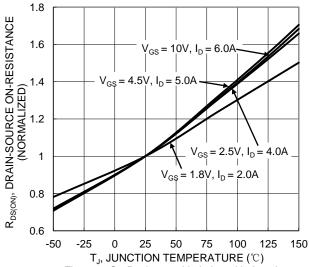
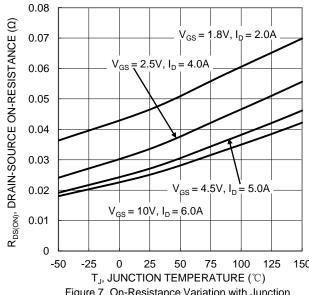
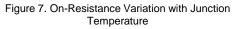


Figure 6. On-Resistance Variation with Junction Temperature







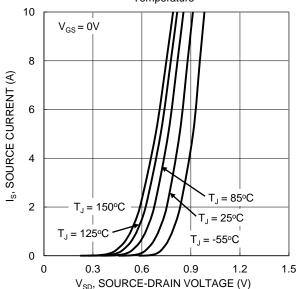


Figure 9. Diode Forward Voltage vs. Current

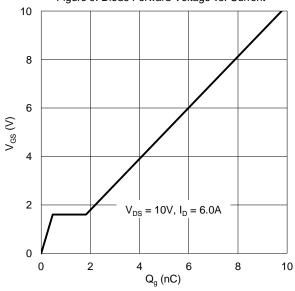


Figure 11. Gate Charge

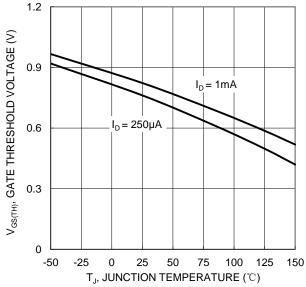


Figure 8. Gate Threshold Variation vs. Junction Temperature

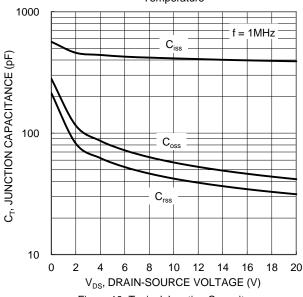
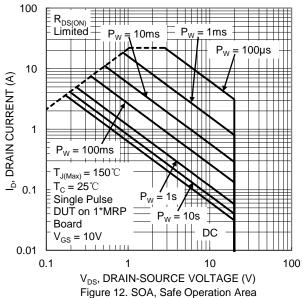


Figure 10. Typical Junction Capacitance





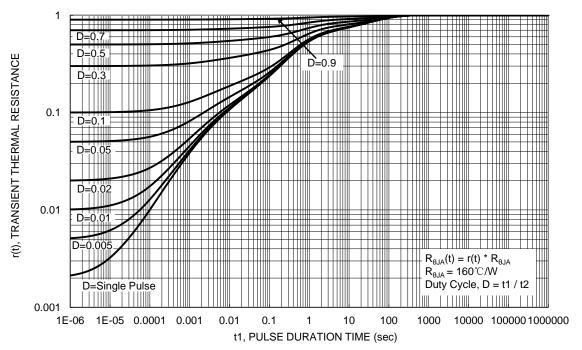


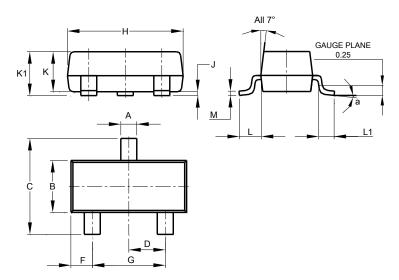
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT23

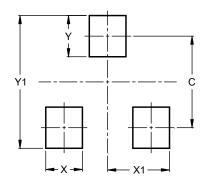


| SOT23                |       |       |       |  |  |  |  |
|----------------------|-------|-------|-------|--|--|--|--|
| Dim                  | Min   | Max   | Тур   |  |  |  |  |
| Α                    | 0.37  | 0.51  | 0.40  |  |  |  |  |
| В                    | 1.20  | 1.40  | 1.30  |  |  |  |  |
| С                    | 2.30  | 2.50  | 2.40  |  |  |  |  |
| D                    | 0.89  | 1.03  | 0.915 |  |  |  |  |
| F                    | 0.45  | 0.60  | 0.535 |  |  |  |  |
| G                    | 1.78  | 2.05  | 1.83  |  |  |  |  |
| Н                    | 2.80  | 3.00  | 2.90  |  |  |  |  |
| J                    | 0.013 | 0.10  | 0.05  |  |  |  |  |
| K                    | 0.890 | 1.00  | 0.975 |  |  |  |  |
| K1                   | 0.903 | 1.10  | 1.025 |  |  |  |  |
| L                    | 0.45  | 0.61  | 0.55  |  |  |  |  |
| L1                   | 0.25  | 0.55  | 0.40  |  |  |  |  |
| M                    | 0.085 | 0.150 | 0.110 |  |  |  |  |
| а                    | 0°    | 8°    |       |  |  |  |  |
| All Dimensions in mm |       |       |       |  |  |  |  |

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

## SOT23



| Dimensions | Value (in mm) |
|------------|---------------|
| С          | 2.0           |
| Х          | 0.8           |
| X1         | 1.35          |
| Y          | 0.9           |
| Y1         | 2.9           |

February 2018

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EFC2J004NUZTDG P85W28HP2F-7071 DMN1053UCP4-7 SQJ469EP-T1-GE3 NTE2384 NTE6400A DMC2700UDMQ-7
DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 SSM6P54TU,LF DMP22D4UFO-7B IPS60R3K4CEAKMA1
DMN1006UCA6-7 DMN16M9UCA6-7 STF5N65M6 IRF40H233XTMA1 IPSA70R950CEAKMA1 IPSA70R2K0CEAKMA1 STU5N65M6
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